DECLARATION FOR U.S. PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention **entitled:**

·	S USING THE CONNECT		ND PRINTED BOARD CO	
the specification of	of which is attached hereto un	nless the following is ch	ecked	
was filed on _	AUGUST 29, 2003 as Unite	ed States Application No	ımber or PCT International	
Application Nu	umber <u>PCT/JP2003/011033</u>	and was amended on	(if appl	icable).
I hereby state that claim(s), as amend	I have reviewed and underst	and the contents of the red above.	above-identified specification	, including the
I acknowledge the Regulations, § 1.5	e duty to disclose information 66.	n which is material to pa	tentability as defined in Title	37, Code of Federal
for patent or inver	ntor's certificate listed below	and have also identified	Code, § 119 (a) – (d) of any fo d below any foreign application for which priority is claimed	on for patent or
	ate naving a filling date before	e diat of the application	for which priority is claimed	Priority Claimed
(List prior foreign applications. See	JP2002-277256	Japan	24.09.2002	⊠ Yes □ No
note A)	(Number)	(Country)	(Day/Month/Year Filed)	Z Ics Z Ivo
				. □ Vas □ Na
	(Number)	(Country)	(Day/Month/Year Filed)	☐ Yes ☐ No
	•		· · · · · · · · · · · · · · · · · · ·	
	(Number)	(Country)		☐ Yes ☐ No
	(Nulliber)	(Country)	(Day/Month/Year Filed)	
				☐ Yes ☐ No
	(Number)	(Country)	(Day/Month/Year Filed)	
(See note B)	See attached list for	r additional prior foreign	n applications	
insofar as the subj in the manner pro information whicl	ect matter of each of the clar wided by the first paragraph h is material to patentability	ims of this application is of Title 35, United Stat as defined in Title 37,	of any United States applications not disclosed in the prior United Economics Code, § 112, I acknowledge Code of Federal Regulations, national or PCT internations	ited States application ge the duty to disclose § 1.56 which became
(List prior U.S.			Stat	tus
Applications)	Application Serial No.)	(Filing Date)	Patented Pend	ding Abandoned
	Application Serial No.)	(Filing Date)	Patented Pend	ding Abandoned
		, 	☐ Patented ☐ Pend	ding Abandoned
(Application Serial No.)	(Filing Date)		

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

23850

Please direct all communications to the following address:

23850
PATENT TRADEMARK OFFICE

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, ' 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

(See note C)	Full name of sole or f Inventor's signature Residence Post Office Address	rist inventor (given name, family name) Asoah Harasawer Yokohama-shi, Japan c/o J.S.T.Mfg.Co.,LTD. 4-4-36, Tarumachi, Kohoku-ku, Yokoha	HARASAWA, Masaaki Date S.O. S. Soo S Citizenship Japan ma-shi, Kanagawa 222-0001, Japan
	Full name of second i Inventor's signature Residence Post Office Address	nventor (given name, family name)	Date Citizenship
	Full name of third inv Inventor's signature Residence Post Office Address	entor (given name, family name)	Date Citizenship
	Full name of fourth in Inventor's signature Residence Post Office Address	ventor (given name, family name)	Date Citizenship
	Full name of fifth inventor's signature Residence Post Office Address	entor (given name, family name)	Date Citizenship